By Express Mail #EV402735703US

Attorney Docket No.: 5367-47

Check box if applicable: □ *DUPLICATE*

UTILITY PATENT APPLICATION TRANSMITTAL

Submit an original and a duplicate for fee processing (Only for new nonprovisional applications under 37 C.F.R. § 1.53(b))

Dated: October 30, 2003

17497 U.S. PTO 10/696882

Mail Stop **Patent Application** Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

Transmitted herewith for filing is the utility patent application of:

Inventor(s): Stefan BADER, Hans-Jurgen LUGAUER, Volker HARLE, Berthold HAHN

For: Method for Depositing a Material on a Substrate Wafer

Enclosed are:

- Transmittal letter (2x) with Fee Computation Sheet
- General Authorization For Payment of Fees (2x)
- Specification, Claims 1 to 12 & Abstract (12 pages)
- One (1) sheet(s) of drawing(s) (Figs. 1A to 1C)
- Check for \$770.00 for filing fee
- Information Disclosure Statement
- PTO Form SB/08A with copies (4 docs.) of cited references
- Return Receipt Postcard

This application is to be assigned to: Osram Opto Semiconductors GmbH
Wernerwerkstrasse 2
93049 Regensburg, Germany

Please charge my Deposit Account No. 03-2412 in the amount of §. A duplicate copy of this sheet is enclosed.

- [x] The Commissioner is hereby authorized to charge payment of the following fees associated with this application or credit any overpayment to Deposit Acct. No. 03-2412.
 - [x] Any additional filing fees required under 37 CFR 1.16.
 - [x] Any patent application processing fees under 37 CFR 1.17
 - [x] Any filing fees under 37 CFR 1.16 for presentation of extra claims.
- [x] Priority is claimed for this invention and application, corresponding applications having been filed in **Germany** on **October 31, 2002**, No. 102 50 915.8.

Respectfully submitted, COHEN, PONTANI, LIEBERMAN & PAVANE

By

Thomas Langer Reg. No. 27,264

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Attorney Docket No.: 5367-47

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Dated: October 30, 2003

Mail Stop Patent Application Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

In re Application of: Stefan BADER et al.

For: Method for Depositing a Material on a Substrate Wafer

The filing fee has been calculated as shown below:

FOR:	Col. 1	Col. 2	SMALL ENTITY		OTHER THAN SMALL ENTITY	
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BASIC FEE				\$378		\$770
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INDEPENDENT CLAIMS	<u>1</u> - 3 =	<u>0</u>	x 43 =	\$	x 86 =	\$
[] MULTIPLE DEPENDENCY			+\$145 =	\$	+290	\$
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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

·		
In re Applica	tion of	
Stefan BADE	ER et al.	Check box if applicable:
Serial No.:	n/a	□ DUPLICATE
Filed:	concurrently	
For:	Method for Depositing a Material on a Substrate Wafer	

GENERAL AUTHORIZATION FOR PAYMENT OF FEES AND PETITIONS FOR EXTENSIONS OF TIME

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- [X] Any filing fees required under 37 CFR §1.16.
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- [X] The issue fee set in 37 CFR 1.18 at 3 months from mailing of the Notice of Allowance, pursuant to 37 CFR 1.311 (b) provided the fee has not already been paid by check.
- [X] Any filing fees under 37 CFR 1.16 for presentation of extra claims.

Respectfully submitted, COHEN, PONTANI, LIEBERMAN & PAVANE

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Dated: October 30, 2003